

N32H488xE

Product Brief

N32H488 series adopts a 32-bit ARM Cortex-M4F core, with a maximum operating frequency of 240MHz, supporting floating-point unit and DSP instructions. It integrates up to 512-KB embedded flash, 192-KB SRAM (including 32-KB CCM SRAM), and 4-KB Backup SRAM. It also integrates 4x 12bit 4.7Msps ADCs, 8x 12bit DAC, 4x PGA, 7x COMP, USB FS Device, USB HS DualRole, U(S)ART, I2C, SPI, CAN-FD, Ethernet, and other communication interfaces. It supports DVP interface, SDIO, FEMC, xSPI high-speed storage interfaces, I2S audio interface, super high-resolution timer, multiple advanced control timers, general timers, basic timers, low-power timers. It also features a built-in hardware acceleration engine for cryptographic algorithms, supporting AES/TDES, SHA, SM3, SM4, MD5 algorithms, TRNG true random number generator, and CRC16/32.

Key Feature

- **CPU Core**
 - 32-bit ARM Cortex-M4F + FPU, single-cycle hardware multiplication and division instruction, support DSP instruction and MPU
 - Built-in 8-KB instruction Cache supporting Flash acceleration unit for zero-wait program execution
 - Frequency up to 240 MHz, 300 DMIPS
- **Memories**
 - 512-KByte of embedded Flash memory with ECC
 - ◆ Supports encryption, multi-user partition and data protection
 - ◆ 10,000 erase/write cycles and 10-years data retention
 - 160-KByte of general SRAM with hardware parity checking
 - 32-KByte of CCM SRAM with ECC, defaults to general SRAM after power-up, configurable as CCM SRAM
 - 4-KByte of Backup SRAM with ECC available in Standby mode
- **Power Modes**
 - Run mode: 45 mA/MHz@240 MHz (peripherals off, 3.3 V@25°C)
 - Stop0 mode: SRAM and all registers can be configured to retention, RTC run
 - Standby mode: 6uA, all backup registers and Backup SRAM retained, all IOs retained, optional RTC run
 - VBAT mode: 4uA, all backup registers and Backup SRAM retained, optional RTC run
- **Clock**
 - HSE: 4MHz~32MHz high-speed external crystal oscillator
 - LSE: 32.768KHz low-speed external crystal oscillator
 - Built-in multiple high speed PLLs

- MCO: Supports 2-channel clock outputs, which can be configured independently as clock output
- HSI: High-speed internal RC 8MHz, -1.5% to +2% accuracy (full temperature range)
- LSI: Low-speed internal RC 32KHz, +/-10% accuracy (full temperature range)

- **Reset**

- Supports power-on/brown-out/external pin reset
- Supports watchdog reset
- Supports programmable voltage detection

- **GPIOs**

- Up to 118 GPIOs

- **Communication Interfaces**

- 1x USB2.0 FS Device interface, built-in PHY, supports crystal-less mode
- 6x SPI interfaces, 2x I2S interfaces, support half/full duplex mode, multiplexed with SPI interfaces
- U(S)ART interfaces
 - ◆ 4x USART interfaces (support ISO7816, IrDA, LIN)
 - ◆ 4x UART interfaces
 - ◆ TX/RX of USART3/UART5/UART8 can be mapped to all pins
- 4x I2C interfaces(Master/Slave) with speed up to 1 MHz where slave mode support dual address response
- 3x CAN-FD bus interface, TX/RX can be mapped to all pins
- 1x IEEE-802.3-2002 compatible Ethernet MAC interface, supports 10M/100M Ethernet, IEEE1588 synchronized Ethernet protocol
- 1x DVP (Digital Video Port) supporting 8/10/12/16 bit data

- **High Performance Analog Interfaces**

- 4x 12bit ADCs with 4.7Msps
 - ◆ Multiple precision configuration, support 12-bit, 10-bit, 8-bit, 6-bit sampling precision, resolution up to 16-bit with hardware oversample
 - ◆ Up to 16 external single-ended input channels, 3 internal single-ended input channels, support differential mode and single-ended mode
- 8x 12bit DAC
 - ◆ DAC1~4: Support 1 internal output channel and 1 external output channel, with a sampling rate of 1Msps. Support output channel buffered/unbuffered modes.
 - ◆ DAC5~8: Support 1 internal output channel and 1 external output channel, with a sampling rate of 15Msps. Only support output channel buffered/unbuffered modes.
- 4x rail-to-rail PGAs, support differential mode and single-ended mode

- 7x high-speed comparators (COMP)
- Supports 1 reference voltage VREFBUF (2.048V/2.5V/2.9V configurable)
- 1x temperature sensor
- **High Speed External Memory Interfaces**
 - 1x xSPI interface, supporting external SRAM, PSRAM and Flash, supporting XIP
 - 1x FEMC (Flexible External Memory Controller) interface, supporting external SRAM, PSRAM, NOR Flash and NAND Flash, 8/16-bit data bus width configurable
 - 1x SDIO interface, support SD/SDIO/MMC format
- **Mathematical hardware accelerator CORDIC for motor control functions**
- **Built-in filter mathematical accelerator FMAC, supporting FIR, IIR filtering**
- **DMA Controllers**
 - 2x DMA controller
 - Each controller supports 8 channels
 - Channel source address and destination address can be configured arbitrarily
- **RTC real-time clock**
 - Supports leap-year calendar, alarm event, periodic wake up
 - Supports internal and external clock calibration
- **Timers**
 - 1x 16bit super high-resolution timer (SHRTIM1)
 - ◆ Supports 6x 16-bit timer units, each timer unit has 2 independent channels, with a maximum control precision of 125ps.
 - ◆ Supports 12 independent PWM outputs or 6 pairs of complementary PWM outputs.
 - 3x 16-bit advanced control timers with maximum control precision of 4.16 ns
 - ◆ Support input capture, complementary output, quadrature encoder input etc.
 - ◆ Each timer has 6 independent channels, 4 of which support 4 pairs of complementary PWM output.
 - 10x 16-bit general purpose timers (GTIM1~10)
 - ◆ GTIM1~7, with a maximum control precision of 5.56ns, each timer has up to 4 independent channels, each channel supports input capture, output comparison, PWM generation, and single-pulse mode output.
 - ◆ GTIM8~10, with a maximum control precision of 4.16ns, each timer has up to 4 independent channels, each channel supports input capture, output comparison, PWM generation, and single-pulse mode output, only channel 1 supports complementary output with dead time, supports break input.
 - 2x 32-bit basic timers
 - 2x 16-bit low-power timer, can operate in Stop0 and Standby mode.

- 1x 24-bit SysTick timer.
- 1x 14-bit Window Watchdog (WWDG)
- 1x 12-bit Independent Watchdog (IWDG)

● **Programming Methods**

- Support SWD/JTAG debugging interface.
- Support UART and USB Bootloader

● **Security Features**

- Flash encryption, multi-user partition management unit (SMPU)
- Supports write protection (WRP), multiple read protection (RDP) levels (L0/L1/L2)
- Built-in hardware acceleration engine for cryptographic algorithm
- Supports AES/TDES, SHA, SM3, SM4, and MD5 algorithms
- True random number generator (TRNG)
- CRC16/32 operation
- Supports secure boot, program encryption download, secure firmware update
- Supports external clock failure detection, anti-tamper detection.

● **96-bit UID and 128-bit UCID**

● **Operating Conditions**

- Operating voltage range: 1.8V~3.6V
- Operating temperature range: -40°C ~ 105°C
- ESD: ±4KV (HBM model), ±1KV (CDM model)
- EFT: VDD (+/-4KV, level A), I/O (+/-2KV, level A)

● **Packages**

- LQFP64-1(7mm × 7mm)
- LQFP64(10mm × 10mm)
- LQFP100(14mm × 14mm)
- LQFP144(20mm × 20mm)

● **Ordering Information**

| Reference | Part Number |
|-----------|---|
| N32H488xE | N32H488REL7K, N32H488REL7, N32H488VEL7, N32H488ZEL7 |

1 Ordering Information

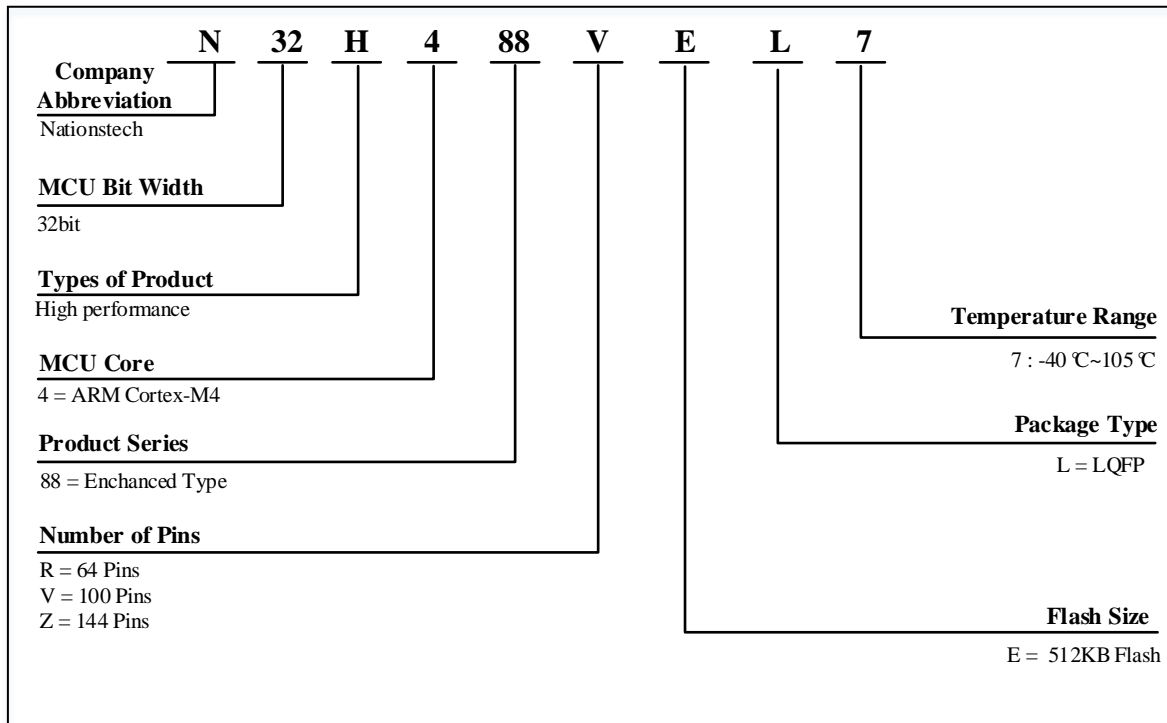


Table 1-1 N32H488 Series Ordering Code

| Ordering Code ⁽¹⁾ | Package | Size | Packaging ⁽²⁾ | SPQ ⁽³⁾ | Temperature range |
|------------------------------|----------|-------------|--------------------------|--------------------|-------------------|
| N32H481REL7K | LQFP64-1 | 7mm x 7mm | Tray | 250 | -40℃ ~ 105℃ |
| N32H488REL7 | LQFP64 | 10mm x 10mm | Tray | 160 | -40℃ ~ 105℃ |
| N32H488VEL7 | LQFP100 | 14mm x 14mm | Tray | 90 | -40℃ ~ 105℃ |
| N32H488ZEL7 | LQFP144 | 20mm x 20mm | Tray | 60 | -40℃ ~ 105℃ |

1. For the latest detailed-ordering information, please refer to the Selection Guide.
2. The packaging provided is the basic packaging. If user has any other requirements, please contact Naitons.
3. Minimum packaging quantity.

2 Product Configurations

Table 2-1 N32H488 Series Product Configuration

| Device | | N32H488REL7K | N32H488REL7 | N32H488VEL7 | N32H488ZEL7 |
|-------------------------------|-------------------------|-----------------------------------|-------------|--------------------|-------------|
| Operating Condition | | 1.8~3.6V/-40~105℃ | | | |
| CPU Frequency | | ARM Cortex-M4F @240MHz, 300DMIPS | | | |
| Flash Capacity (KB) | | 512 | 512 | 512 | 512 |
| Total SRAM (KB) | General SRAM | 160 | 160 | 160 | 160 |
| | CCM SRAM ⁽¹⁾ | 32 | | | |
| | Backup SRAM | 4 | | | |
| Times | SHRTIM | 1*16bit | | | |
| | ATIM | 3*16bit | | | |
| | GTIM | 7*16bit 3*16bit ⁽²⁾ | | | |
| | BTIM | 2*32bit | | | |
| | LPTIM | 2*16bit | | | |
| | SysTick timer | 1 | | | |
| | WWDG | 1*14bit | | | |
| | IWDG | 1*12bit | | | |
| | RTC | Yes | | | |
| Communication Interfaces | SPI/I2S | 6/2 | 5/2 | 6/2 | |
| | I ² C | 4 | | | |
| | USART | 4 | | | |
| | UART | 4 | | | |
| | USB FS Device | No | Yes | | |
| | USB HS DualRole | Yes | | | |
| | FDCAN | 3 | | | |
| | Ethernet | Yes | | | |
| Memory Expansion | XSPI | Yes | | | |
| | FEMC | No | No | Yes ⁽³⁾ | Yes |
| | SDIO | Yes | | | |
| Human-computer interaction | DVP | Yes | | | |
| GPIO | | 56 | 54 | 85 | 118 |
| WKUP Pins | | 4 | 4 | 5 | 5 |
| DMA | | 2 | | | |
| Number of channels | | 16Channel | | | |

| | | | | |
|---------------------------------|--|----------------|----------------|----------------|
| 12bit ADC Number of channels | 4 47Channel ⁽⁴⁾ | 4 26Channel | 4 42Channel | 4 51Channel |
| 12bit DAC Number of channels | 8 8 (4 External/Internal + 4 Internal) | | | |
| PGA | 4 | | | |
| COMP | 7 | | | |
| VREFBUF | Yes | | | |
| Algorithm Support | DES/3DES、AES、SHA1/SHA224/SHA256、SM3、SM4、MD5、 CRC16/CRC32 | | | |
| TRNG | Yes | | | |
| Cordic | Yes | | | |
| FMAC | Yes | | | |
| Security Protection | Read-write protection (RDP/WRP), storage encryption, partition protection, secure boot | | | |
| Package | LQFP64-1 | LQFP64 | LQFP100 | LQFP144 |

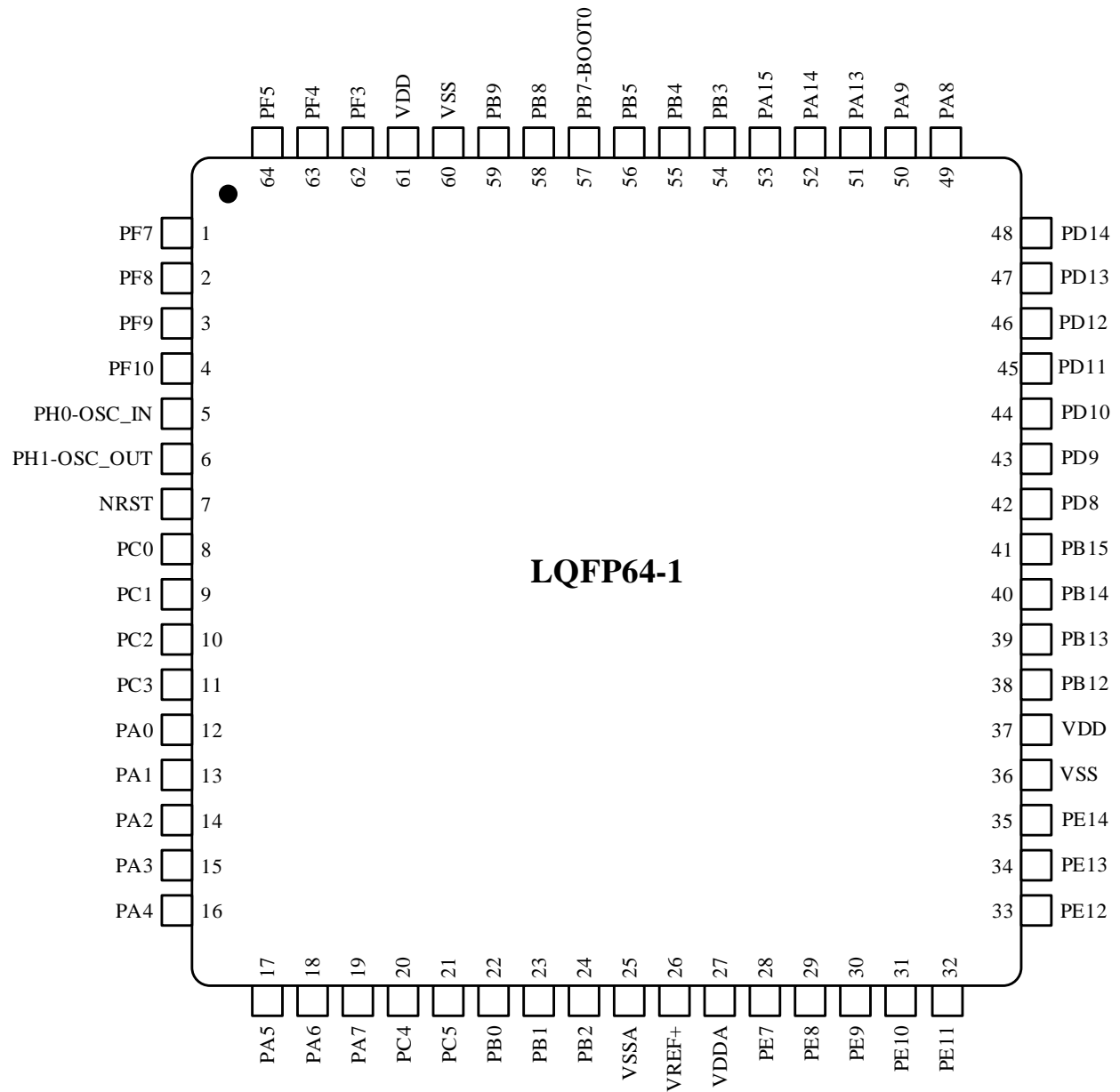
Notes:

- (1) CCM SRAM is powered up as general SRAM by default, and users can configure it as CCM SRAM.
- (2) Supports break input, Channel 1 supports complementary channel output.
- (3) Only supports address bus and data bus multiplexing.
- (4) 2 ADCs are multiplexed with OSC_IN and OSC_OUT, 2 ADCs are multiplexed with USB_HS_DP and USB_HS_DM, ADC1 has 14 channels, ADC2 has 16 channels, ADC3 has 19 channels, ADC4 has 18 channels

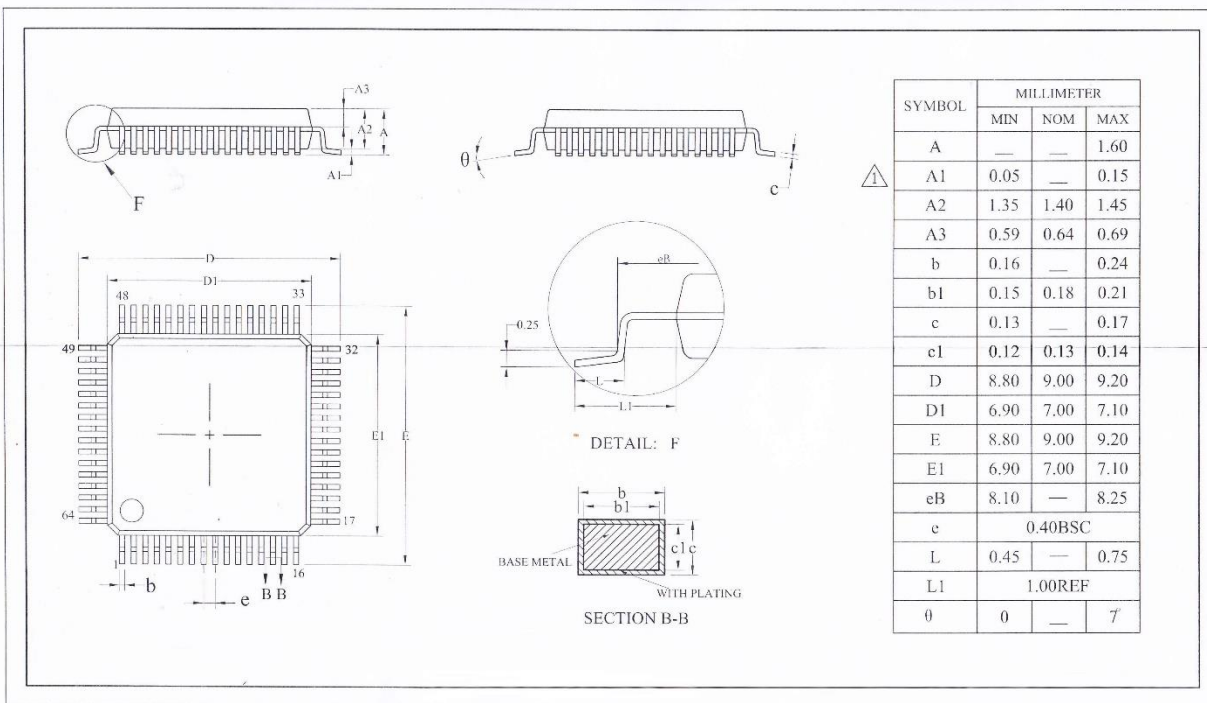
3 Package

3.1 LQFP64-1

3.1.1 LQFP64-1 Pinout

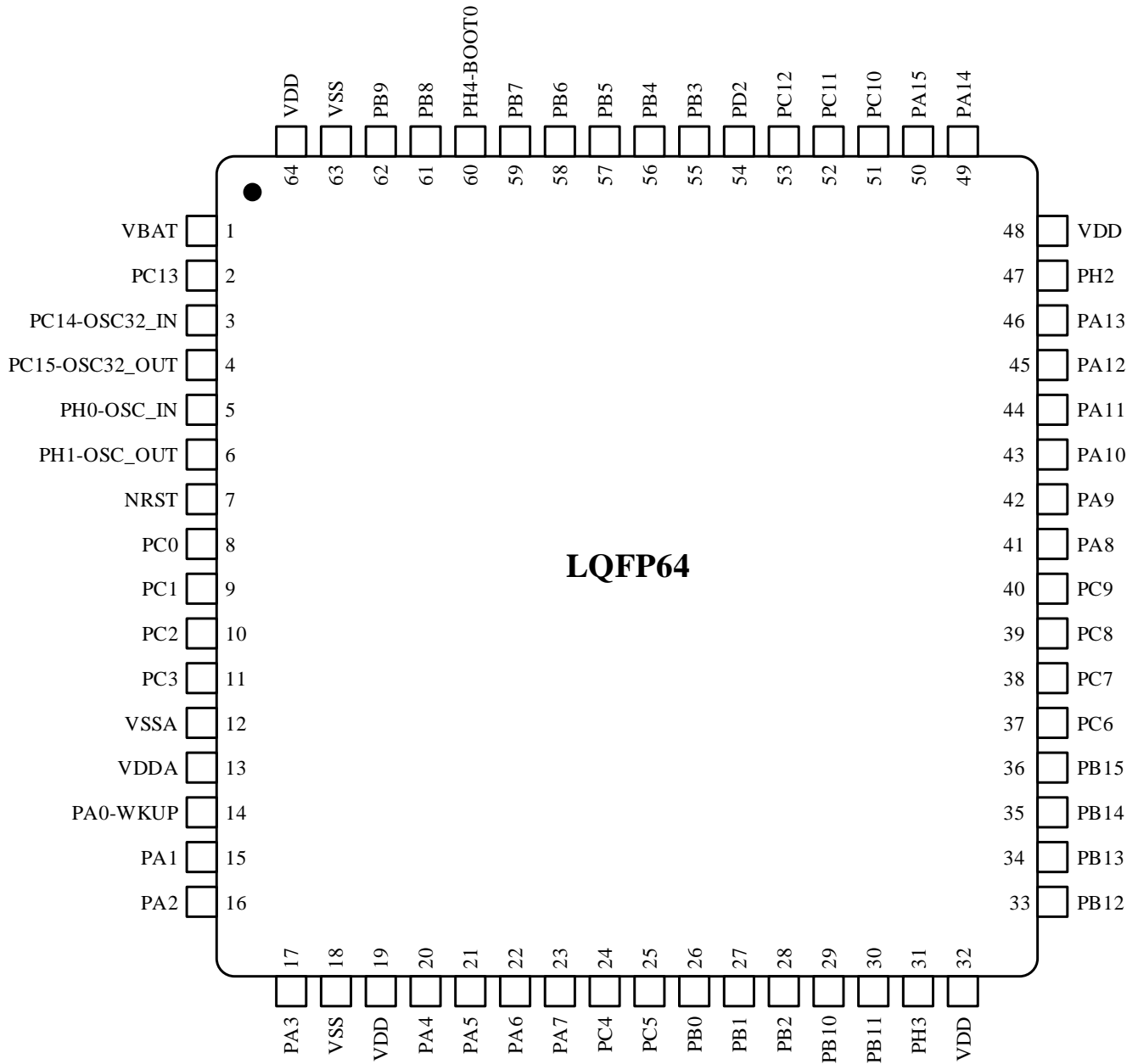


3.1.2 LQFP64-1 Package

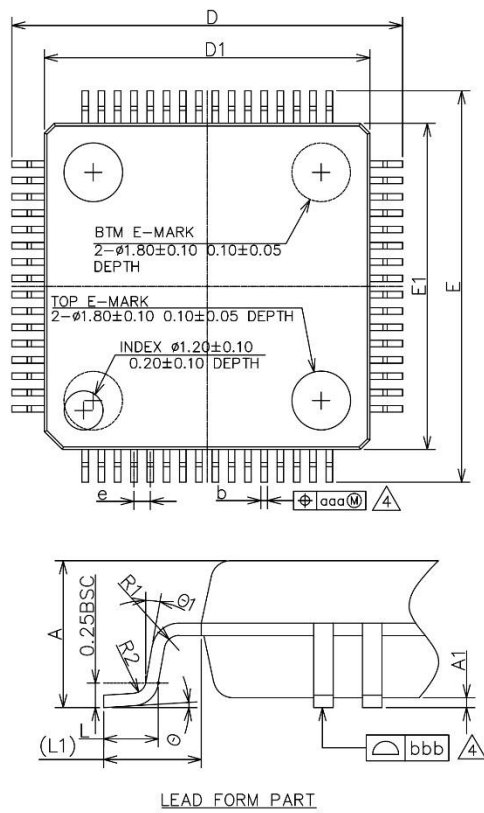


3.2 LQFP64

3.2.1 LQFP64 Pinout



3.2.2 LQFP64 Package



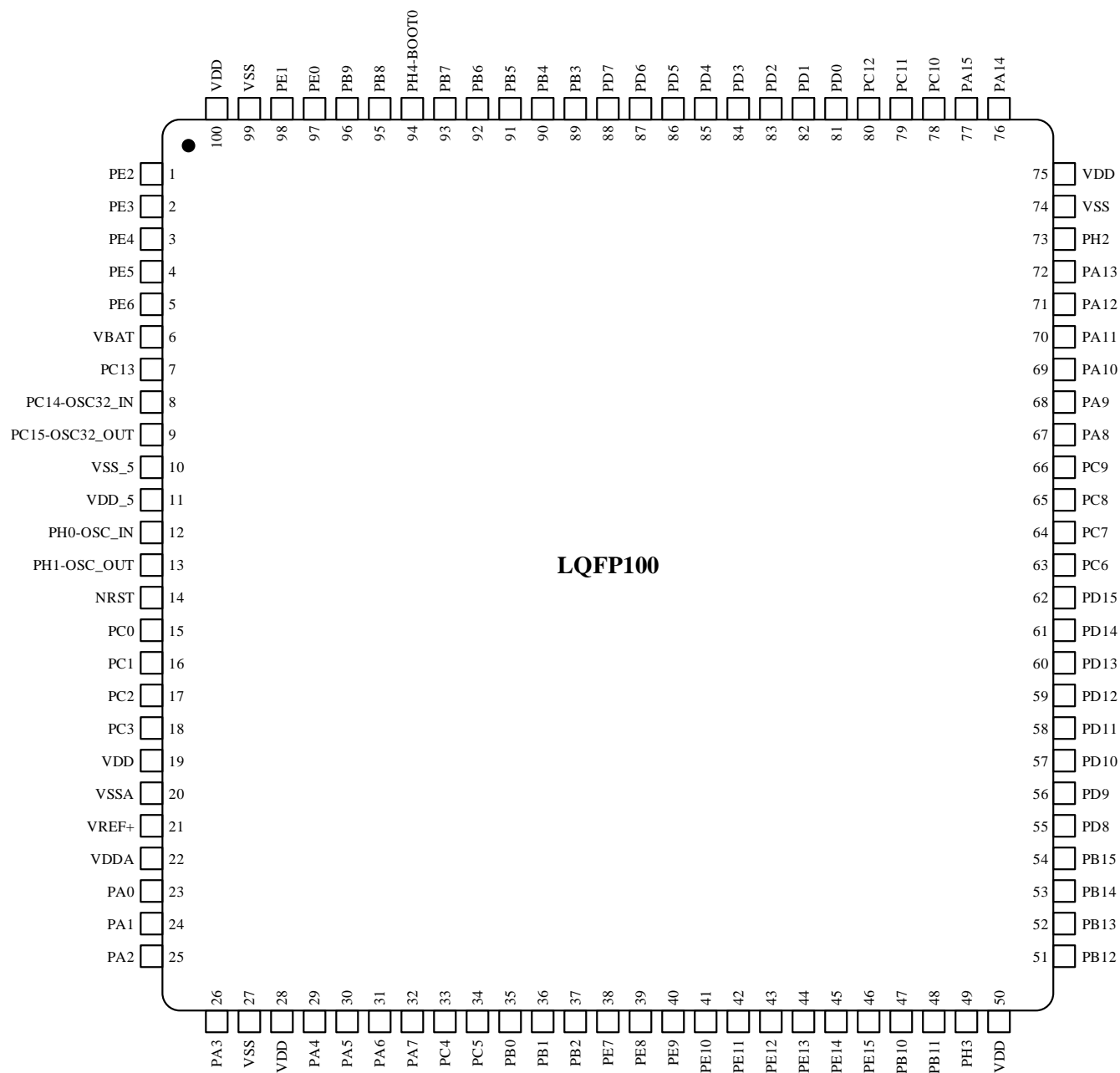
COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

| SYMBOL | MIN | NOM | MAX |
|------------|---------|-------|-------|
| A | — | — | 1.60 |
| A1 | 0.05 | — | 0.15 |
| A2 | 1.35 | 1.40 | 1.45 |
| A3 | 0.59 | 0.64 | 0.69 |
| b | 0.18 | — | 0.27 |
| b1 | 0.17 | 0.20 | 0.23 |
| c | 0.13 | — | 0.18 |
| c1 | 0.117 | 0.127 | 0.137 |
| D | 11.95 | 12.00 | 12.05 |
| D1 | 9.90 | 10.00 | 10.10 |
| E | 11.95 | 12.00 | 12.05 |
| E1 | 9.90 | 10.00 | 10.10 |
| e | 0.40 | 0.50 | 0.60 |
| H | 11.09 | 11.13 | 11.17 |
| L | 0.53 | — | 0.70 |
| L1 | 1.00REF | | |
| R1 | 0.15REF | | |
| R2 | 0.13REF | | |
| θ | 0° | 3.5° | 7° |
| $\theta 1$ | 0° | — | — |
| $\theta 2$ | 11° | 12° | 13° |
| $\theta 3$ | 11° | 12° | 13° |
| aaa | 0.08 | | |
| bbb | 0.08 | | |

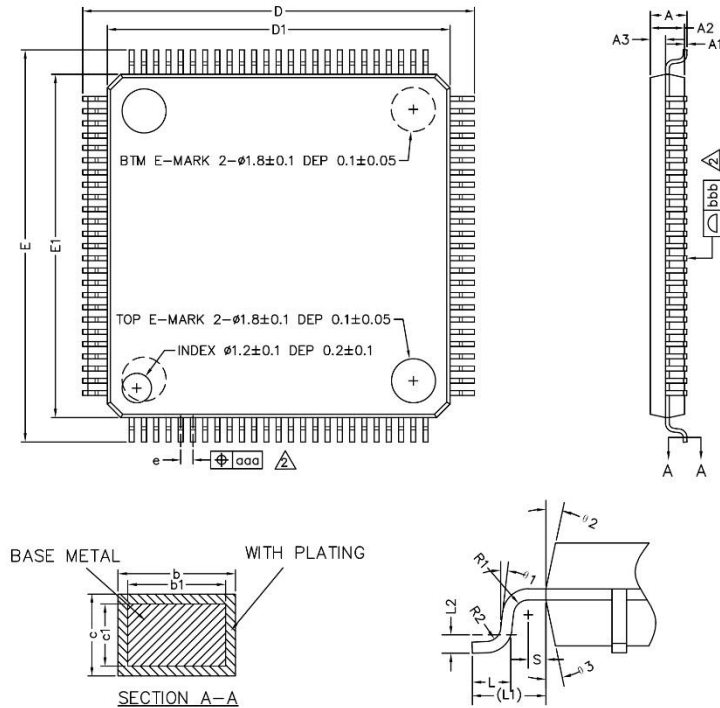
NOTES:
1. ALL DIMENSIONS REFER TO JEDEC STANDARD MS026 BCD
DO NOT INCLUDE MOLD FLASH, GATE BURR OR PROTRUSION.

3.3 LQFP100

3.3.1 LQFP100 Pinout



3.3.2 LQFP100 Package



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

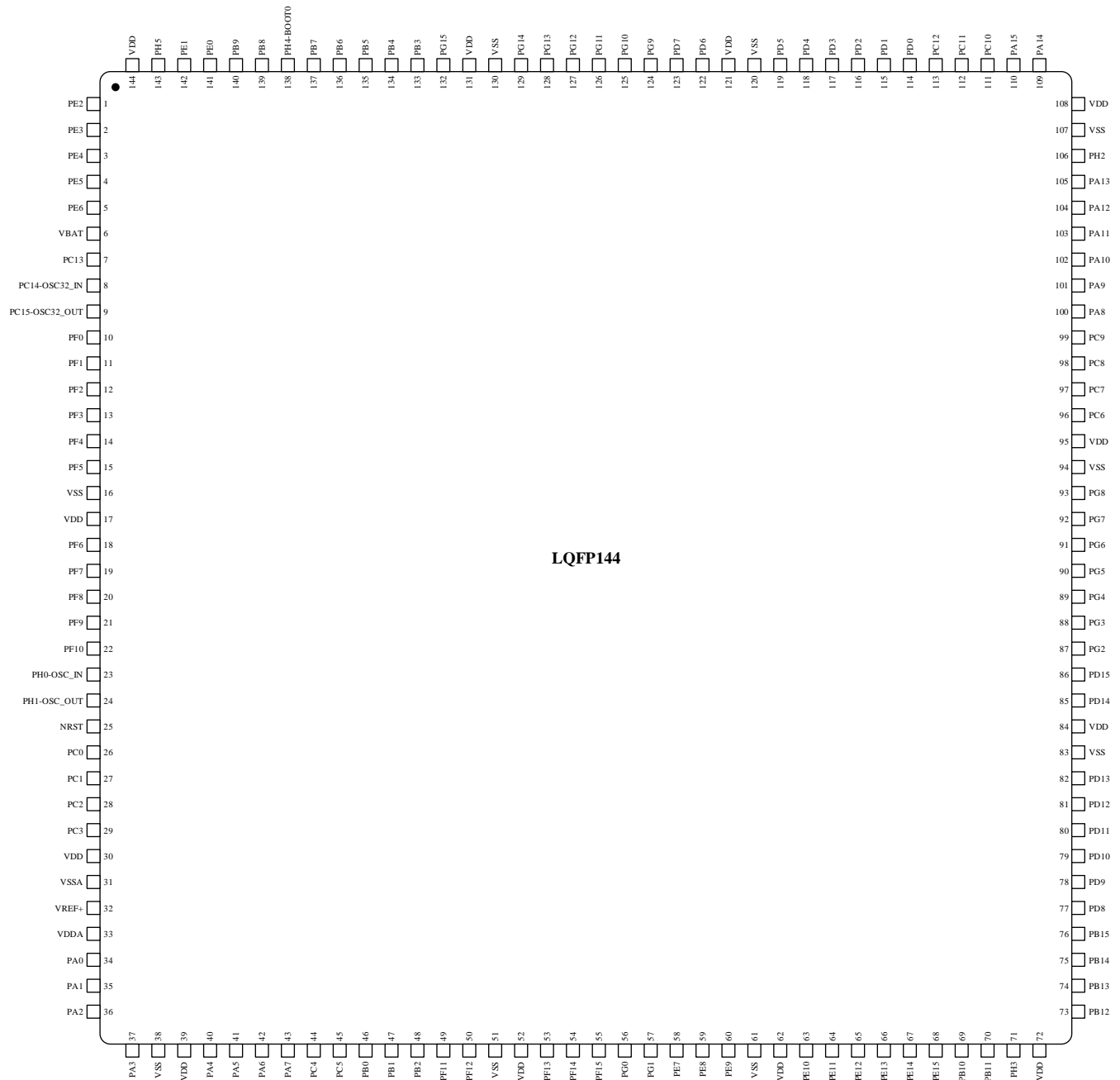
| SYMBOL | MIN | NOM | MAX |
|----------------|---------|-------|-------|
| A | — | — | 1.60 |
| A1 | 0.05 | — | 0.15 |
| A2 | 1.35 | 1.40 | 1.45 |
| A3 | 0.59 | 0.64 | 0.69 |
| b | 0.17 | — | 0.27 |
| b1 | 0.17 | 0.20 | 0.23 |
| c | 0.13 | — | 0.18 |
| c1 | 0.12 | 0.127 | 0.134 |
| D | 15.80 | 16.00 | 16.20 |
| D1 | 13.90 | 14.00 | 14.10 |
| E | 15.80 | 16.00 | 16.20 |
| E1 | 13.90 | 14.00 | 14.10 |
| e | 0.50BSC | | |
| L | 0.45 | 0.60 | 0.75 |
| L1 | 1.00REF | | |
| L2 | 0.25BSC | | |
| R1 | 0.08 | — | — |
| R2 | 0.08 | — | 0.20 |
| S | 0.20 | — | — |
| θ ₁ | 0° | 3.5° | 7° |
| θ ₂ | 0° | — | — |
| θ ₃ | 11° | 12° | 13° |
| aaa | 0.08 | | |
| bbb | 0.08 | | |

NOTES:

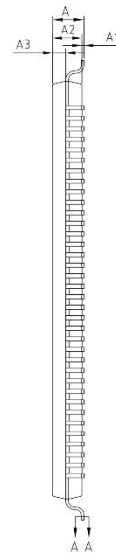
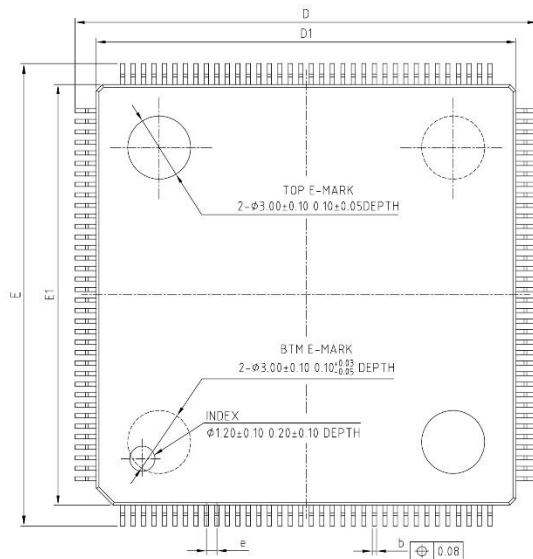
ALL DIMENSIONS REFER TO JEDEC STANDARD MS-026 BED DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

3.4 LQFP144

3.4.1 LQFP144 Pinout

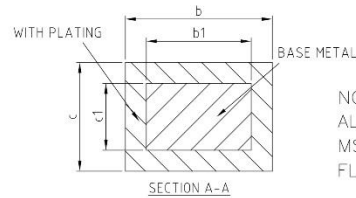
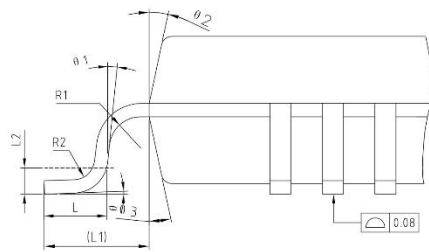


3.4.2 LQFP144 Package



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

| SYMBOL | MIN | NOM | MAX |
|------------|---------|-------|-------|
| A | — | — | 1.60 |
| A1 | 0.05 | — | 0.15 |
| A2 | 1.35 | 1.40 | 1.45 |
| A3 | 0.59 | 0.64 | 0.69 |
| b | 0.17 | — | 0.27 |
| b1 | 0.17 | 0.20 | 0.23 |
| c | 0.127 | — | 0.18 |
| c1 | 0.119 | 0.127 | 0.135 |
| D | 21.80 | 22.00 | 22.20 |
| D1 | 19.90 | 20.00 | 20.10 |
| E | 21.80 | 22.00 | 22.20 |
| E1 | 19.90 | 20.00 | 20.10 |
| e | 0.40 | 0.50 | 0.60 |
| L | 0.45 | 0.60 | 0.75 |
| L1 | 1.00REF | | |
| L2 | 0.25BSC | | |
| R1 | 0.08 | — | — |
| R2 | 0.08 | — | — |
| θ | 0° | — | 7° |
| $\theta 1$ | 0° | — | — |
| $\theta 2$ | 11° | 12° | 13° |
| $\theta 3$ | 11° | 12° | 13° |



NOTES:
ALL DIMENSIONS REFER TO JEDEC STANDARD
MS-026 BFB DO NOT INCLUDE MOLD
FLASH OR PROTRUSIONS.

4 Version History

| Version | Date | Changes |
|---------|----------|------------------|
| V1.0.0 | 2025.5.9 | Initial release. |
| | | |

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